

74VHC14; 74VHCT14

Hex inverting Schmitt trigger

Rev. 01 — 17 August 2009

Product data sheet

1. General description

The 74VHC14; 74VHCT14 are a high-speed Si-gate CMOS devices and are pin compatible with Low-power Schottky TTL (LSTTL). They are specified in compliance with JEDEC standard No. 7A.

The 74VHC14; 74VHCT14 provide six inverting buffers with Schmitt-trigger action. They are capable of transforming slowly changing input signals into sharply defined, jitter-free output signals.

2. Features

- Balanced propagation delays
- All inputs have Schmitt-trigger action
- Inputs accept voltages higher than V_{CC}
- Input levels:
 - ◆ The 74VHC14 operates with CMOS input level
 - ◆ The 74VHCT14 operates with TTL input level
- ESD protection:
 - ◆ HBM EIA/JESD22-A114E exceeds 2000 V
 - ◆ MM EIA/JESD22-A115-A exceeds 200 V
 - ◆ CDM EIA/JESD22-C101C exceeds 1000 V
- Multiple package options
- Specified from $-40\text{ }^{\circ}\text{C}$ to $+85\text{ }^{\circ}\text{C}$ and from $-40\text{ }^{\circ}\text{C}$ to $+125\text{ }^{\circ}\text{C}$

3. Ordering information

Table 1. Ordering information

Type number	Package			Version
	Temperature range	Name	Description	
74VHC14D 74VHCT14D	-40 °C to +125 °C	SO14	plastic small outline package; 14 leads; body width 3.9 mm	SOT108-1
74VHC14PW 74VHCT14PW	-40 °C to +125 °C	TSSOP14	plastic thin shrink small outline package; 14 leads; body width 4.4 mm	SOT402-1
74VHC14BQ 74VHCT14BQ	-40 °C to +125 °C	DHVQFN14	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 × 3 × 0.85 mm	SOT762-1

4. Functional diagram

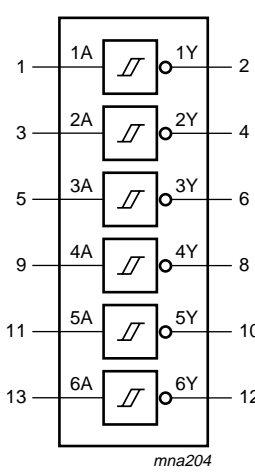


Fig 1. Logic symbol

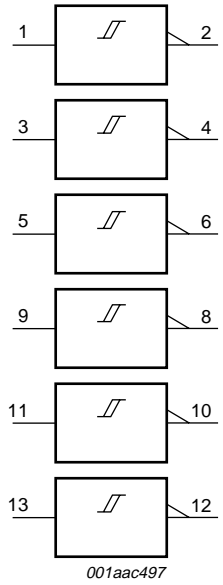


Fig 2. IEC logic symbol

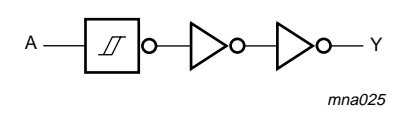
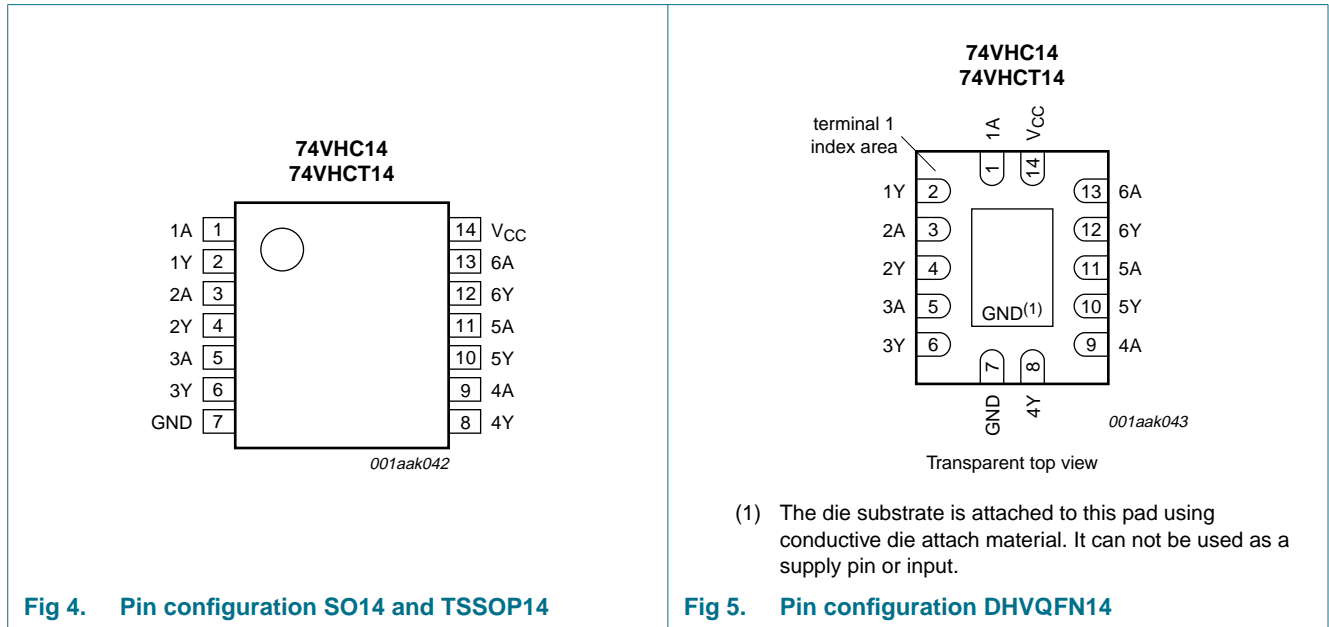


Fig 3. Logic diagram (one Schmitt-trigger)

5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2. Pin description

Symbol	Pin	Description
1A	1	data input 1
1Y	2	data output 1
2A	3	data input 2
2Y	4	data output 2
3A	5	data input 3
3Y	6	data output 3
GND	7	ground (0 V)
4Y	8	data output 4
4A	9	data input 4
5Y	10	data output 5
5A	11	data input 5
6Y	12	data output 6
6A	13	data input 6
V _{CC}	14	supply voltage

6. Functional description

Table 3. Function table^[1]

Input	Output
nA	nY
L	H
H	L

[1] H = HIGH voltage level;
L = LOW voltage level.

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		-0.5	+7.0	V
V_I	input voltage		-0.5	+7.0	V
I_{IK}	input clamping current	$V_I < -0.5$ V	[1] -20	-	mA
I_{OK}	output clamping current	$V_O < -0.5$ V or $V_O > V_{CC} + 0.5$ V	[1] -20	+20	mA
I_O	output current	$V_O = -0.5$ V to $(V_{CC} + 0.5)$ V	-25	+25	mA
I_{CC}	supply current		-	+75	mA
I_{GND}	ground current		-75	-	mA
T_{stg}	storage temperature		-65	+150	°C
P_{tot}	total power dissipation	$T_{amb} = -40$ °C to +125 °C	[2] -	500	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For SO14 packages: above 70 °C the value of P_{tot} derates linearly at 8 mW/K.
For TSSOP14 packages: above 60 °C the value of P_{tot} derates linearly at 5.5 mW/K.
For DHVQFN14 packages: above 60 °C the value of P_{tot} derates linearly at 4.5 mW/K.

8. Recommended operating conditions

Table 5. Operating conditions

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
74VHC14						
V_{CC}	supply voltage		2.0	5.0	5.5	V
V_I	input voltage		0	-	5.5	V
V_O	output voltage		0	-	V_{CC}	V
T_{amb}	ambient temperature		-40	+25	+125	°C
74VHCT14						
V_{CC}	supply voltage		4.5	5.0	5.5	V
V_I	input voltage		0	-	5.5	V
V_O	output voltage		0	-	V_{CC}	V
T_{amb}	ambient temperature		-40	+25	+125	°C

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Typ	Max	Min	Max	Min	Max	
74VHC14										
V _{OH}	HIGH-level output voltage	V _I = V _{T+} or V _{T-}								
		I _O = -50 μA; V _{CC} = 2.0 V	1.9	2.0	-	1.9	-	1.9	-	V
		I _O = -50 μA; V _{CC} = 3.0 V	2.9	3.0	-	2.9	-	2.9	-	V
		I _O = -50 μA; V _{CC} = 4.5 V	4.4	4.5	-	4.4	-	4.4	-	V
		I _O = -4.0 mA; V _{CC} = 3.0 V	2.58	-	-	2.48	-	2.40	-	V
		I _O = -8.0 mA; V _{CC} = 4.5 V	3.94	-	-	3.80	-	3.70	-	V
V _{OL}	LOW-level output voltage	V _I = V _{T+} or V _{T-}								
		I _O = 50 μA; V _{CC} = 2.0 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 50 μA; V _{CC} = 3.0 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 50 μA; V _{CC} = 4.5 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 4.0 mA; V _{CC} = 3.0 V	-	-	0.36	-	0.44	-	0.55	V
		I _O = 8.0 mA; V _{CC} = 4.5 V	-	-	0.36	-	0.44	-	0.55	V
I _I	input leakage current	V _I = 5.5 V or GND; V _{CC} = 0 V to 5.5 V	-	-	0.1	-	1.0	-	2.0	μA
I _{CC}	supply current	V _I = V _{CC} or GND; I _O = 0 A; V _{CC} = 5.5 V	-	-	2.0	-	20	-	40	μA
C _I	input capacitance		-	3	10	-	10	-	10	pF
C _O	output capacitance		-	4	-	-	-	-	-	pF
74VHCT14										
V _{OH}	HIGH-level output voltage	V _I = V _{T+} or V _{T-}								
		I _O = -50 μA; V _{CC} = 4.5 V	4.4	4.5	-	4.4	-	4.4	-	V
		I _O = -8.0 mA; V _{CC} = 4.5 V	3.94	-	-	3.80	-	3.70	-	V
V _{OL}	LOW-level output voltage	V _I = V _{T+} or V _{T-}								
		I _O = 50 μA; V _{CC} = 4.5 V	-	0	0.1	-	0.1	-	0.1	V
		I _O = 8.0 mA; V _{CC} = 4.5 V	-	-	0.36	-	0.44	-	0.55	V
I _I	input leakage current	V _I = 5.5 V or GND; V _{CC} = 0 V to 5.5 V	-	-	0.1	-	1.0	-	2.0	μA
I _{CC}	supply current	V _I = V _{CC} or GND; I _O = 0 A; V _{CC} = 5.5 V	-	-	2.0	-	20	-	40	μA
ΔI _{CC}	additional supply current	per input pin; V _I = V _{CC} - 2.1 V; other pins at V _{CC} or GND; I _O = 0 A; V _{CC} = 4.5 V to 5.5 V	-	-	1.35	-	1.5	-	1.5	mA
C _I	input capacitance		-	3	10	-	10	-	10	pF
C _O	output capacitance		-	4	-	-	-	-	-	pF

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit see [Figure 7](#).

Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Typ ^[1]	Max	Min	Max	Min	Max	
74VHC14										
t _{pd}	propagation delay	nA to nY; see Figure 6 [2]								
		V _{CC} = 3.0 V to 3.6 V								
		C _L = 15 pF	-	4.3	12.8	1.0	15.0	1.0	16.0	ns
		C _L = 50 pF	-	5.8	16.3	1.0	18.0	1.0	20.5	ns
		V _{CC} = 4.5 V to 5.5 V								
		C _L = 15 pF	-	3.2	8.6	1.0	10.0	1.0	11.0	ns
		C _L = 50 pF	-	4.2	10.6	1.0	12.0	1.0	13.5	ns
C _{PD}	power dissipation capacitance	f _i = 1 MHz; V _I = GND to V _{CC} [3]	-	10	-	-	-	-	-	pF
74VHCT14										
t _{pd}	propagation delay	nA to nY; see Figure 6 [2]								
		V _{CC} = 4.5 V to 5.5 V								
		C _L = 15 pF	-	4.0	7.0	1.0	8.0	1.0	9.0	ns
		C _L = 50 pF	-	5.4	8.0	1.0	9.0	1.0	10.0	ns
C _{PD}	power dissipation capacitance	f _i = 1 MHz; V _I = GND to V _{CC} [3]	-	12	-	-	-	-	-	pF

[1] Typical values are measured at nominal supply voltage (V_{CC} = 3.3 V and V_{CC} = 5.0 V).

[2] t_{pd} is the same as t_{PLH} and t_{PHL}.

[3] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o) \text{ where:}$$

f_i = input frequency in MHz;

f_o = output frequency in MHz;

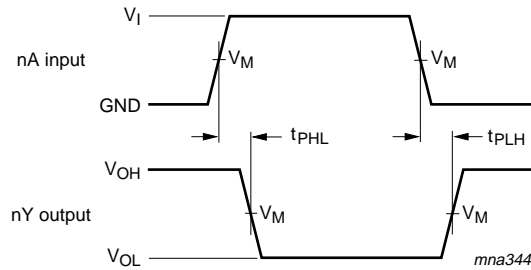
C_L = output load capacitance in pF;

V_{CC} = supply voltage in V;

N = number of inputs switching;

Σ(C_L × V_{CC}² × f_o) = sum of the outputs.

11. Waveforms

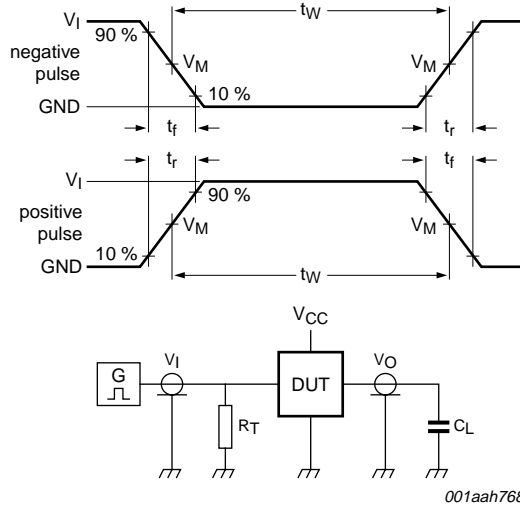


Measurement points are given in [Table 8](#).
 V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

Fig 6. Input to output propagation delays

Table 8. Measurement points

Type	Input	Output
	V_M	V_M
74VHC14	$0.5V_{CC}$	$0.5V_{CC}$
74VHCT14	1.5 V	$0.5V_{CC}$



Test data is given in [Table 9](#).
 Definitions test circuit:
 R_T = Termination resistance should be equal to output impedance Z_o of the pulse generator
 C_L = Load capacitance including jig and probe capacitance

Fig 7. Load circuitry for measuring switching times

Table 9. Test data

Type	Input		Load	Test
	V_I	t_r, t_f	C_L	
74VHC14	V_{CC}	≤ 3.0 ns	50 pF, 15 pF	t_{PLH}, t_{PHL}
74VHCT14	3.0 V	≤ 3.0 ns	50 pF, 15 pF	t_{PLH}, t_{PHL}

12. Transfer characteristics

Table 10. Transfer characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); see Figure 8 and Figure 9.

Symbol	Parameter	Conditions	25 °C			-40 °C to +85 °C		-40 °C to +125 °C		Unit
			Min	Typ	Max	Min	Max	Min	Max	
74VHC14										
V_{T+}	positive-going threshold voltage	$V_{CC} = 3.0$ V	-	-	2.2	-	2.2	-	2.2	V
		$V_{CC} = 4.5$ V	-	-	3.15	-	3.15	-	3.15	V
		$V_{CC} = 5.5$ V	-	-	3.85	-	3.85	-	3.85	V
V_{T-}	negative-going threshold voltage	$V_{CC} = 3.0$ V	0.9	-	-	0.9	-	0.9	-	V
		$V_{CC} = 4.5$ V	1.35	-	-	1.35	-	1.35	-	V
		$V_{CC} = 5.5$ V	1.65	-	-	1.65	-	1.65	-	V
V_H	hysteresis voltage	$V_{CC} = 3.0$ V	0.3	-	1.2	0.3	1.2	0.25	1.2	V
		$V_{CC} = 4.5$ V	0.4	-	1.4	0.4	1.4	0.35	1.4	V
		$V_{CC} = 5.5$ V	0.5	-	1.6	0.5	1.6	0.45	1.6	V
74VHCT14										
V_{T+}	positive-going threshold voltage	$V_{CC} = 4.5$ V	-	-	1.9	-	1.9	-	1.9	V
		$V_{CC} = 5.5$ V	-	-	2.1	-	2.1	-	2.1	V
V_{T-}	negative-going threshold voltage	$V_{CC} = 4.5$ V	0.5	-	-	0.5	-	0.5	-	V
		$V_{CC} = 5.5$ V	0.6	-	-	0.6	-	0.6	-	V
V_H	hysteresis voltage	$V_{CC} = 4.5$ V	0.4	-	1.4	0.4	1.4	0.35	1.4	V
		$V_{CC} = 5.5$ V	0.4	-	1.5	0.4	1.5	0.35	1.5	V

13. Transfer characteristics waveforms

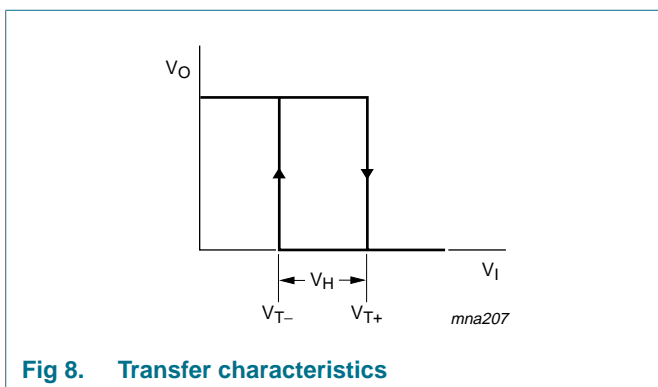


Fig 8. Transfer characteristics

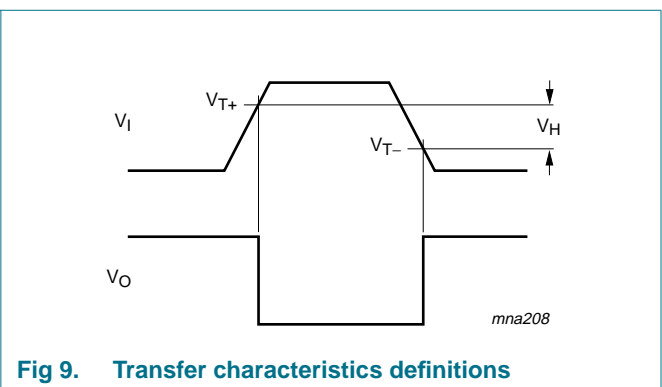
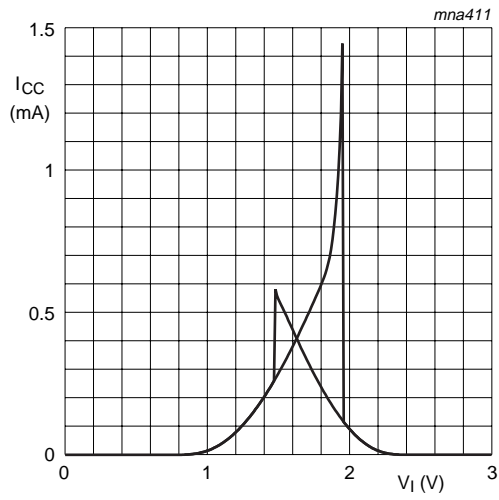
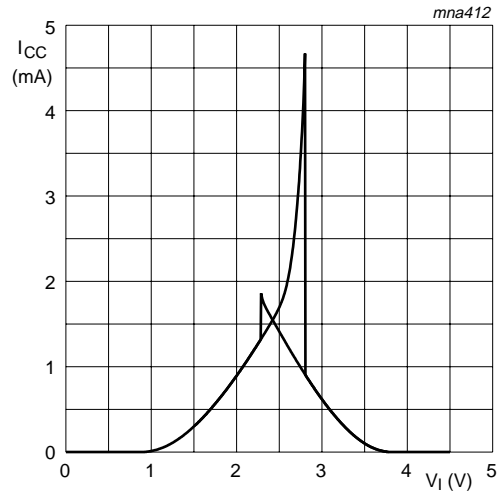


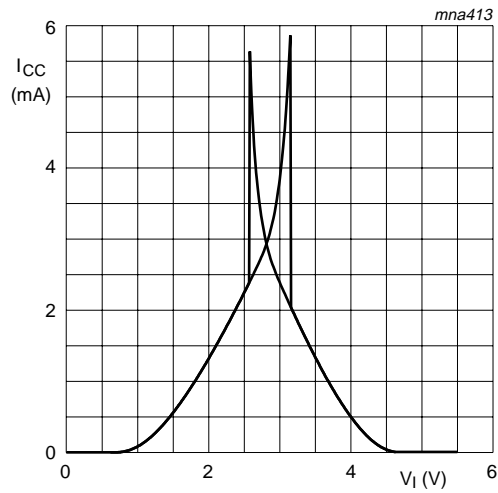
Fig 9. Transfer characteristics definitions



a. $V_{CC} = 3.0\text{ V}$



b. $V_{CC} = 4.5\text{ V}$



c. $V_{CC} = 5.5\text{ V}$

Fig 10. Typical 74VHC transfer characteristics

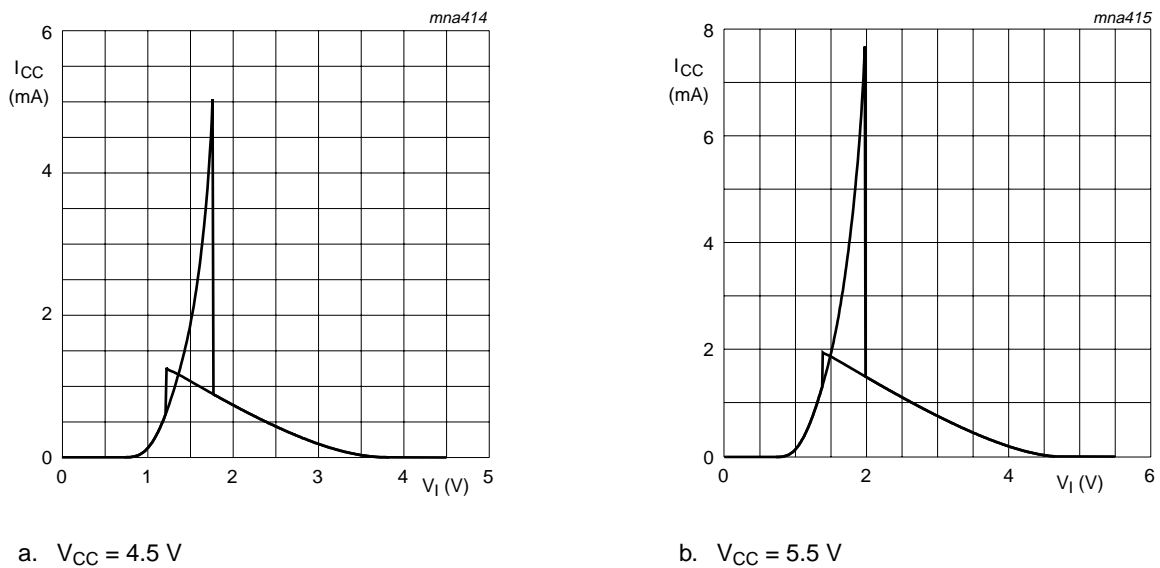
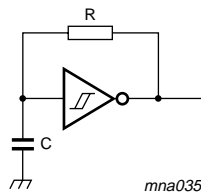


Fig 11. Typical 74VHCT transfer characteristics

14. Application information



For 74VHC14: $f = \frac{1}{T} \approx \frac{1}{0.55 \times RC}$

For 74VHCT14: $f = \frac{1}{T} \approx \frac{1}{0.60 \times RC}$

Fig 12. Relaxation oscillator

15. Package outline

SO14: plastic small outline package; 14 leads; body width 3.9 mm

SOT108-1

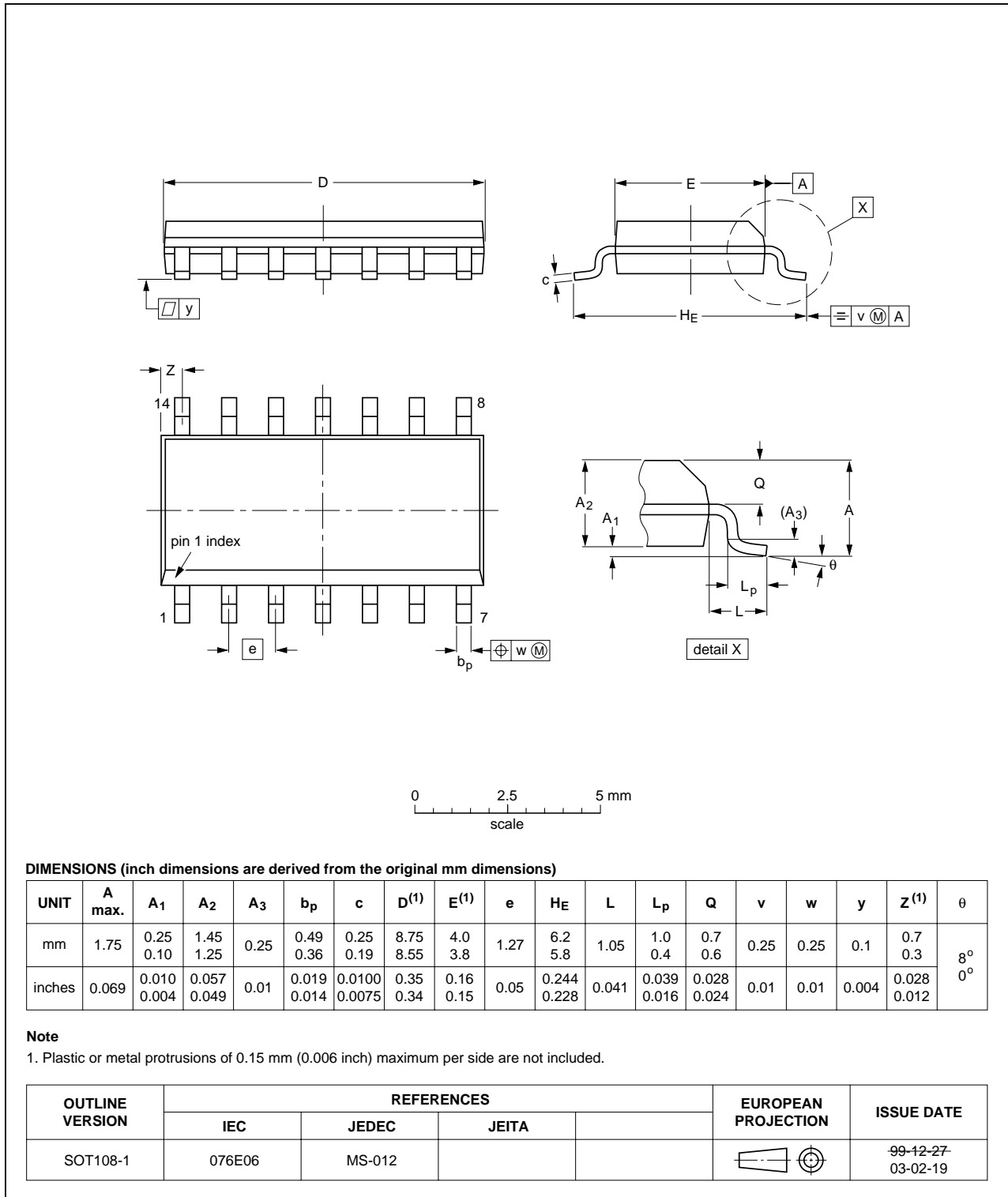


Fig 13. Package outline SOT108-1 (SO14)

TSSOP14: plastic thin shrink small outline package; 14 leads; body width 4.4 mm

SOT402-1

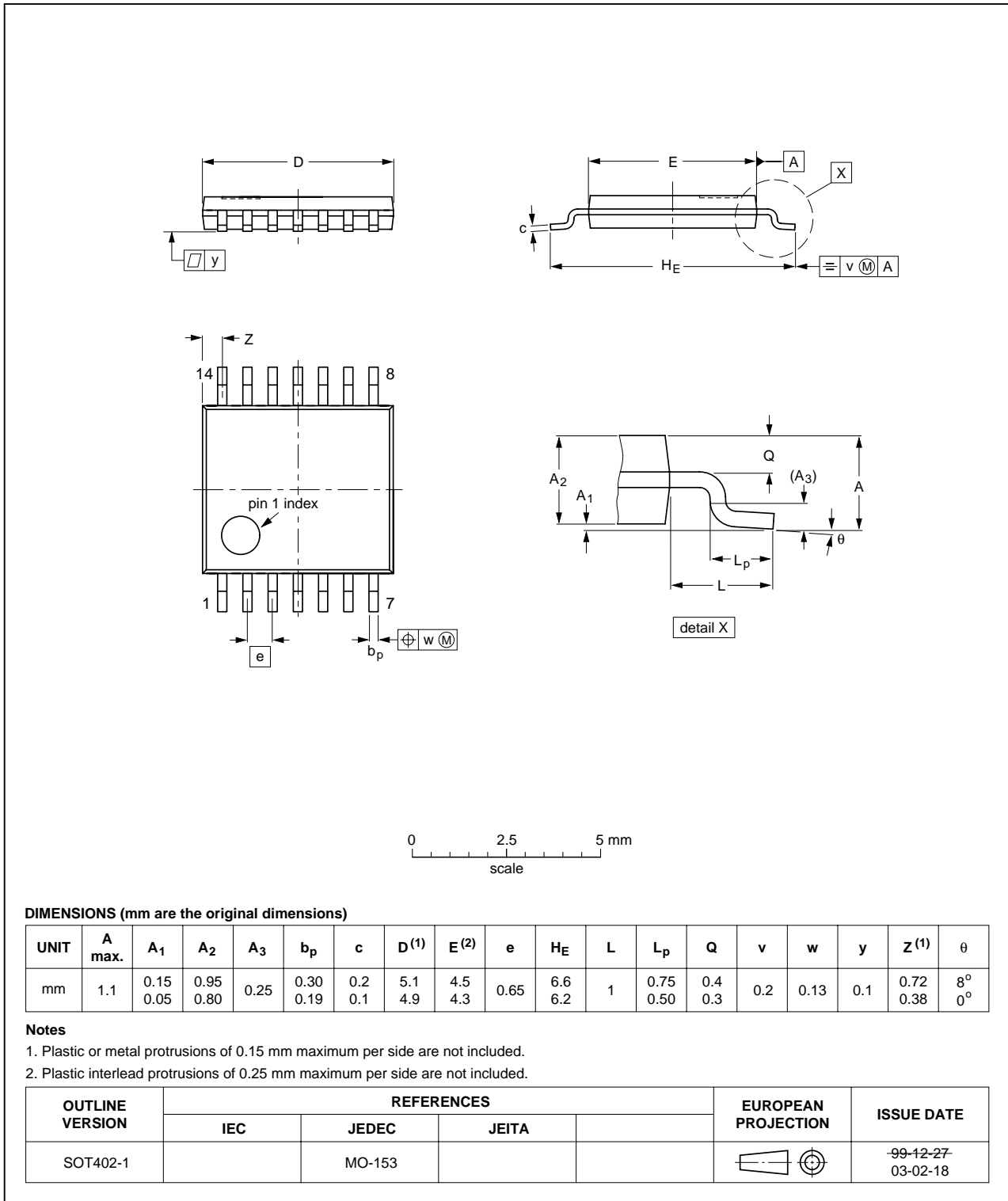


Fig 14. Package outline SOT402-1 (TSSOP14)

DHVQFN14: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 14 terminals; body 2.5 x 3 x 0.85 mm

SOT762-1

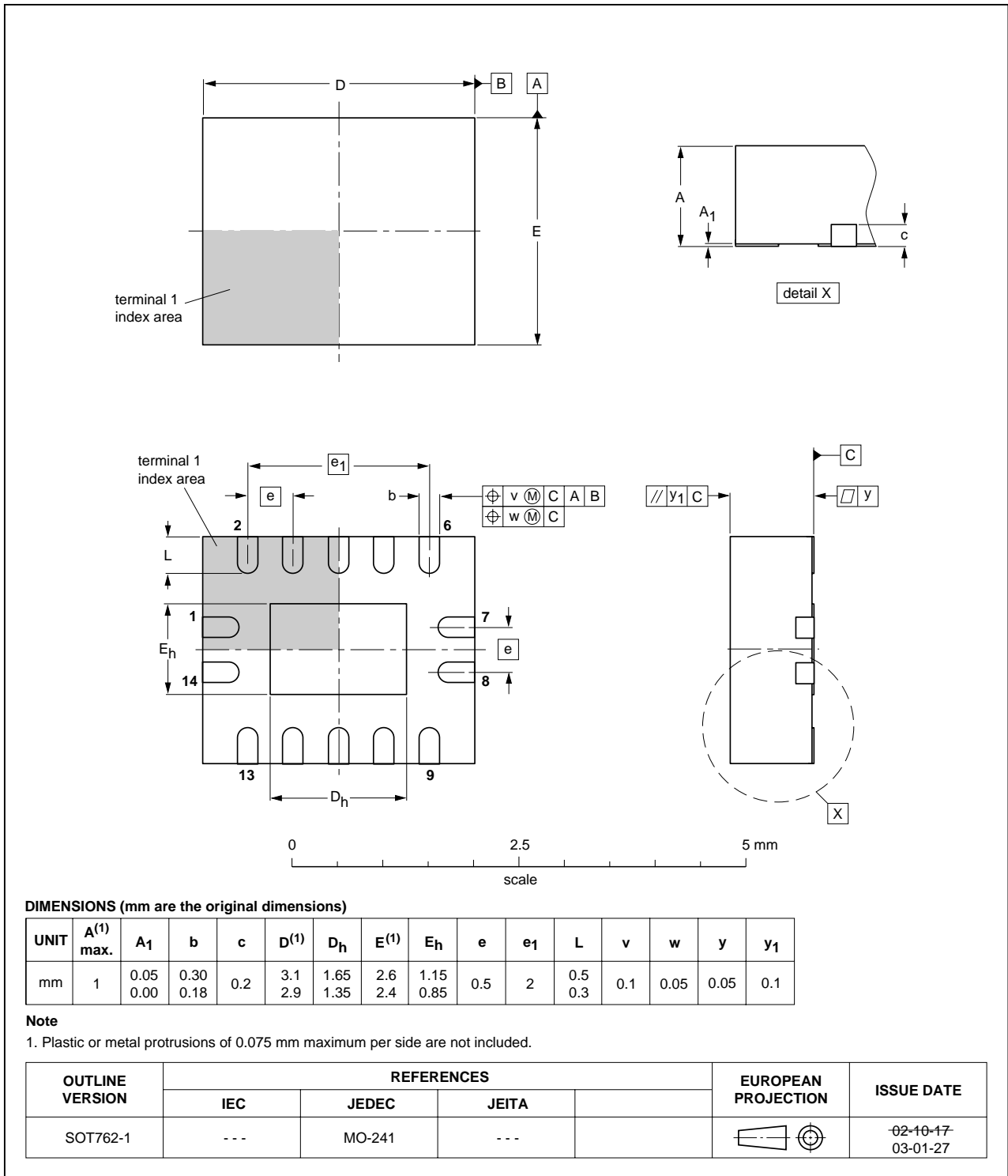


Fig 15. Package outline SOT762-1 (DHVQFN14)

16. Abbreviations

Table 11. Abbreviations

Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal-Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
LSTTL	Low-power Schottky Transistor-Transistor Logic
MM	Machine Model

17. Revision history

Table 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74VHC_VHCT14_1	20090817	Product data sheet	-	-

18. Legal information

18.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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[NLU2G04CMX1TCG](#) [NLV17SZ06DFT2G](#) [NLV27WZ04DFT2G](#) [NLV74HCT14ADTR2G](#) [NLX2G14CMUTCG](#) [NLU1G04AMX1TCG](#)
[SNJ54ACT14W](#) [SNJ54AC04W](#) [NCV1729SN35T1G](#) [TC74VHC04FK\(EL,K\)](#) [NLV74HC04ADTR2G](#) [NLV17SZ04DFT2G](#) [74AUP2G04FW3-](#)
[7](#) [NLU1G04AMUTCG](#) [NLX2G04CMUTCG](#) [NLX2G04AMUTCG](#) [NLV74ACT00DR2G](#) [NLV74AC14DR2G](#) [NLV37WZ14USG](#)
[NLV27WZ04DFT1G](#) [NLV14106BDG](#) [NLU1GU04CMUTCG](#) [NLU1GT14AMUTCG](#) [NLU1G04CMUTCG](#) [NL17SZU04P5T5G](#)
[NL17SG14DFT2G](#) [74LVC06ADTR2G](#) [74LVC04ADR2G](#) [TC7SZ04AFS,L3J](#) [NLU1GT04AMUTCG](#) [NLV37WZ04USG](#)
[NLX3G14FMUTCG](#) [NL17SZ04P5T5G](#) [NL17SG14P5T5G](#) [NLV27WZU04DFT2G](#) [LV0008G100-4EOFN](#)